
FEATURES

- Ø 1.95 mm active area
- Blue enhanced
- High QE at blue range
- Fast rise time

DESCRIPTION

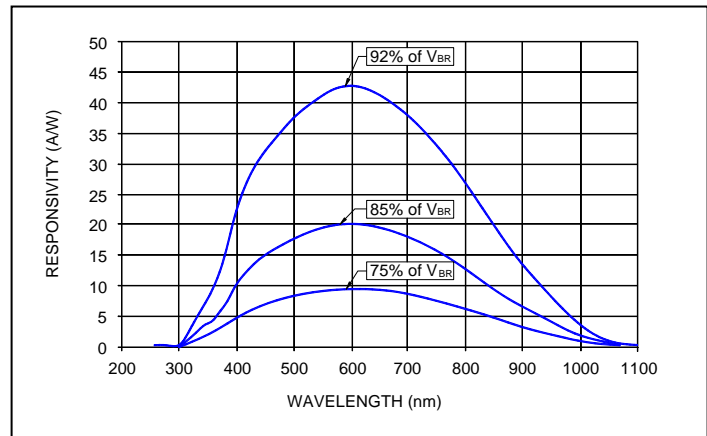
3.0 mm² High Speed, High Gain, Blue Enhanced Avalanche Photodiode with P on N construction. Hermetically packaged in a case isolated TO-5 with a clear borosilicate glass window cap.

APPLICATIONS

- Analytical equipment
- Scintillation
- Medical equipment
- High speed photometry


ABSOLUTE MAXIMUM RATING

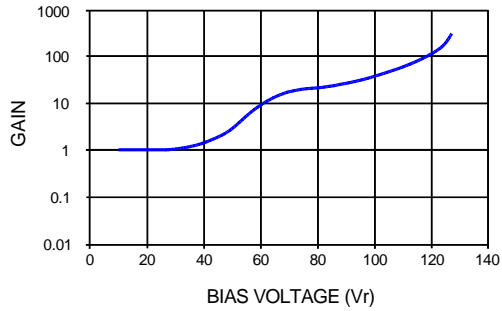
SYMBOL	PARAMETER	MIN	MAX	UNITS
T _{STG}	Storage Temp	-55	+125	°C
T _{OP}	Operating Temp	-40	+85	°C
T _{SOLDERING}	Soldering Temp 10 seconds		+260	°C
	Electrical Power Dissipation @ 22°C	-	100	mW
	Optical Peak Value, once for 1 second	-	200	mW
I _{PH} (DC)	Continuous Optical Operation ≤ 1 mA for signal 50 μs "on" / 1 ms "off"	-	250	μA

SPECTRAL RESPONSE M=100

ELECTRO-OPTICAL CHARACTERISTICS @ 22 °C

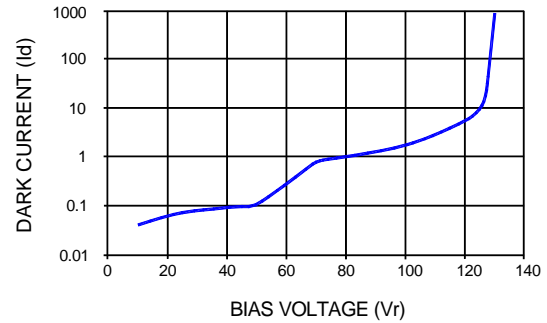
SYMBOL	CHARACTERISTIC	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I _D	Dark Current	M = 100	---	5.0	20.0	nA
C	Capacitance	M = 100	---	10.0	---	pF
V _{BR}	Breakdown Voltage	I _D = 2 μA	100	200	---	V
	Temperature Coefficient of V _{BR}		---	3.5	---	V/K
	Responsivity	M = 100; λ = 400 nm	---	25	---	A/W
		M = 100; λ = 500 nm	---	35	---	
		M = 100; λ = 600 nm	---	40	---	
Δf _{-3dB}	Bandwidth	-3dB	---	175	---	MHz
t _r	Rise Time	λ = 410 nm; R _L = 50 Ω	---	2	---	ns
	Optimum Gain		50	---	80	
	Noise Current	M = 100	---	0.25	---	pA/Hz ^{1/2}
	Max Gain		200	500	---	
NEP	Noise Equivalent Power	M = 100; λ = 410 nm	---	2.5 X 10 ⁻¹⁴	---	W/Hz ^{1/2}

Disclaimer: Due to our policy of continued development, specifications are subject to change without notice.

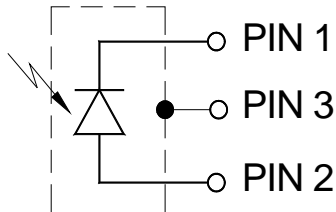
TYPICAL GAIN vs BIAS VOLTAGE



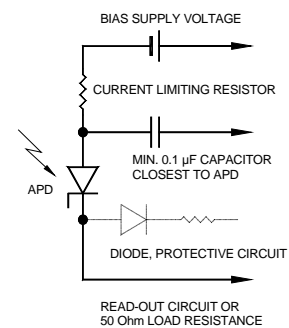
TYPICAL DARK CURRENT vs BIAS VOLTAGE



DEVICE SCHEMATIC



SUGGESTED CIRCUIT SCHEMATIC



APPLICATION NOTES

- Current should be limited by a protecting resistor or current limiting IC inside the power supply.
- Use of low noise read-out IC.
- For high gain applications ($M > 50$) bias voltage should be temperature compensated.
- For low light level applications, blocking of ambient light should be used.

HANDLING PRECAUTIONS:

- Soldering temperature - 260°C for 10 seconds max. The device must be protected against solder flux vapor.
- Minimum pin length - 2 mm
- ESD protection - Standard precautionary measures are sufficient.
- Storage - Store devices in conductive foam.
- Avoid skin contact with window.
- Clean window with Ethyl alcohol if necessary.
- Do not scratch or abrade window.

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